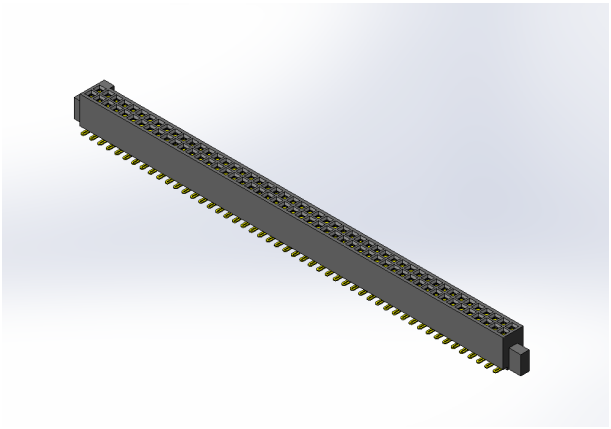
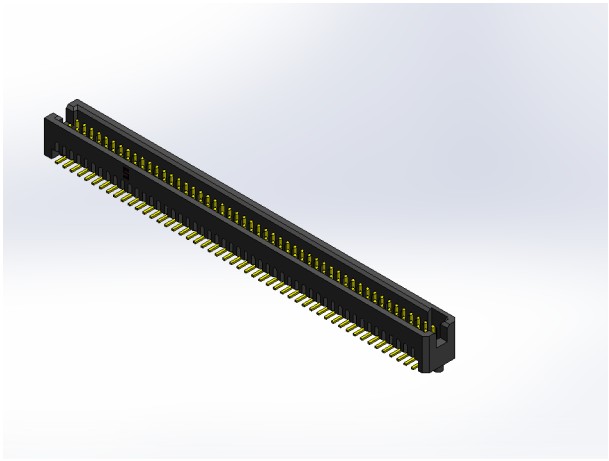
Project Number: Design Qualification Test Report	Tracking Code: 231299_Report_Rev_2		
Requested by: Craig Ryan	Date: 7/2/2013	Product Rev: CM	
Part #: SFM-150-02-F-D / TFM-150-02-F-D-A		Tech: Tony Wagoner	Eng: Eric Mings
Part description: SFM/TFM			Qty to test: 8
Test Start: 12/20/2012	Test Completed: 1/14/2013		





DESIGN QUALIFICATION TEST REPORT

SFM/TFM
SFM-150-02-F-D / TFM-150-02-F-D-A

REVISION HISTORY

DATA	REV.NUM.	DESCRIPTION	ENG
04/25/2013	**1**	**Initial Issue**	**PC**
07/02/2013	**2**	**Update the cover page**	**PC**

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to IS0 10012-l and ANSI/NCSL 2540-1, as applicable.

SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

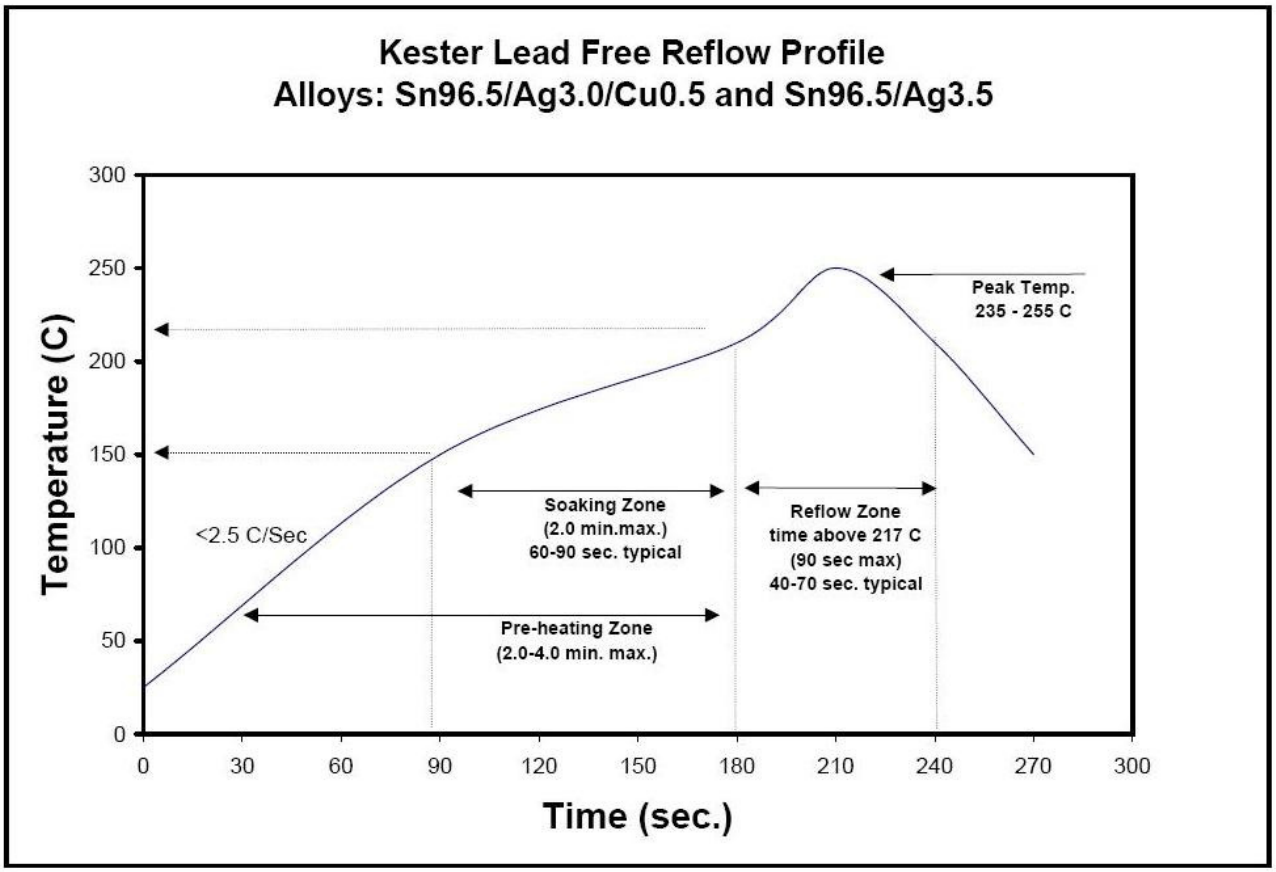
APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

1) All materials were manufactured in accordance with the applicable product specification.
2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
3) The automated procedure is used with aqueous compatible soldering materials.
4) Parts not intended for testing LLCR are visually inspected.
5) Any additional preparation will be noted in the individual test sequences.
6) Solder Information: Lead Free
7) Re-Flow Time/Temp: See accompanying profile.
8) Samtec Test PCBs used: PCB-102834-TST-XX

TYPICAL OVEN PROFILE (Soldering Parts to Test Boards)



FLOWCHARTS

Durability/LLCR

TEST STEP	GROUP A1 3u" Gold (-F) 8 Mated Sets
01	LLCR-1
02	**10 Cycles**
03	LLCR-2
04	Thermal Shock (Mated and Undisturbed)
05	LLCR-3
06	Cyclic Humidity (Mated and Undisturbed)
07	LLCR-4

Thermal Shock = EIA-364-32, Table II, Test Condition I:

-55°C to +85°C 1/2 hour dwell, 100 cycles

Humidity = EIA-364-31, Test Condition B (240 Hours)

and Method III (+25°C to +65°C @ 90% RH to 98% RH)

ambient pre-condition and delete steps 7a and 7b

LLCR = EIA-364-23, LLCR

20 mV Max, 100 mA Max

Use Keithley 580 or 3706 in 4 wire dry circuit mode

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors.*
2) Test Condition 1: -55°C to +85°C
3) Test Time: ½ hour dwell at each temperature extreme
4) Number of Cycles: 100
5) All test samples are pre-conditioned at ambient.
6) All test samples are exposed to environmental stressing in the mated condition.

HUMIDITY:

1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors.*
2) Test Condition B, 240 Hours.
3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
4) All samples are pre-conditioned at ambient.
5) All test samples are exposed to environmental stressing in the mated condition.

LLCR:

1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
    a. <= +5.0 mOhms:---------- Stable
    b. +5.1 to +10.0 mOhms:---------- Minor
    c. +10.1 to +15.0 mOhms: ---------- Acceptable
    d. +15.1 to +50.0 mOhms: ---------- Marginal
    e. +50.1 to +2000 mOhms: ---------- Unstable
    f. >+2000 mOhms:---------- Open Failure

RESULTS

LLCR Durability:

Initial----------8.94 mOhms Max

- **Durability, 10 Cycles**
  - **<= +5.0 mOhms ---------- 192 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------0 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**
- **Thermal Shock**
  - **<= +5.0 mOhms ---------- 192 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------0 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**
- **Humidity**
  - **<= +5.0 mOhms ---------- 192 Points ---------- Stable**
  - **+5.1 to +10.0 mOhms ----------0 Points ---------- Minor**
  - **+10.1 to +15.0 mOhms ----------0 Points ---------- Acceptable**
  - **+15.1 to +50.0 mOhms ----------0 Points ---------- Marginal**
  - **+50.1 to +2000 mOhms----------0 Points ---------- Unstable**
  - **>+2000 mOhms----------0 Points ---------- Open Failure**

DATA SUMMARIES

LLCR Durability:

1) A total of 192 points were measured.
2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets.*
3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
   a. <= +5.0 mOhms: ---------- Stable
   b. +5.1 to +10.0 mOhms: ---------- Minor
   c. +10.1 to +15.0 mOhms: ---------- Acceptable
   d. +15.1 to +50.0 mOhms: ---------- Marginal
   e. +50.1 to +2000 mOhms ---------- Unstable
   f. >+2000 mOhms: ---------- Open Failure

	LLCR Measurement Summaries by Pin Type			
Date	12/20/2012	12/27/2012	1/2/2013	1/14/2013
Room Temp (Deg C)	21	22	22	22
Rel Humidity (%)	36	33	25	32
Technician	Aaron McKim	Tony Wagoner	Tony Wagoner	Aaron McKim
mOhm values	**Actual Initial**	**Delta 10 Cycles**	**Delta Therm Shck**	**Delta Humidity**
	Pin Type 1: Signal			
Average	6.74	0.29	2.56	2.65
St. Dev.	0.47	0.32	1.07	1.07
Min	6.07	0.00	0.00	0.01
Max	8.94	2.12	4.07	4.13
Summary Count	192	192	192	192
Total Count	192	192	192	192

LLCR Delta Count by Category						
	Stable	**Minor**	**Acceptable**	**Marginal**	**Unstable**	**Open**
mOhms	**<=5**	**>5 & <=10**	**>10 & <=15**	**>15 & <=50**	**>50 & <=1000**	**>1000**
10 Cycles	**192**	**0**	**0**	**0**	**0**	**0**
Therm Shck	**192**	**0**	**0**	**0**	**0**	**0**
Humidity	**192**	**0**	**0**	**0**	**0**	**0**

EQUIPMENT AND CALIBRATION SCHEDULES

Equipment #: MO-04
Description: Multimeter /Data Acquisition System
Manufacturer: Keithley
Model: 2700
Serial #: 0798688
Accuracy: See Manual
… Last Cal: 04/30/2013, Next Cal: 04/30/2014

Equipment #: THC-02
Description: Temperature/Humidity Chamber
Manufacturer: Thermotron
Model: SE-1000-6-6
Serial #: 31808
Accuracy: See Manual
… Last Cal: 02/16/2013, Next Cal: 02/16/2014

Equipment #: TSC-01
Description: Vertical Thermal Shock Chamber
Manufacturer: Cincinnatti Sub Zero
Model: VTS-3-6-6-SC/AC
Serial #: 10-VT14993
Accuracy: See Manual
… Last Cal: 05/18/2013, Next Cal: 05/18/2014